English ▼ Search Microchip
Search Data Sheets

PRODUCTS APPLICATIONS DESIGN SUPPORT TRAINING SAMPLE & BUY ABOUT US Contact Us myMicrochip Login

Product Change Notification - JAON-18OBAP766 (Printer Friendly)

Date: 07 Apr 2015

Notification subject: CCB 1554 Initial Notice: Qualification of palladium coated copper (PdCu) bond wire in selected products of the 90K and 120K wafer

technology available in 44L MQFP package at ANAP.

Notification text: PCN Status:

Initial notification

Microchip Parts Affected:

See attachments of affected catalog part numbers (CPN) labeled as...

PCN_JAON-18OBAP766_Affected_CPN.xls PCN_JAON-18OBAP766_Affected_CPN.pdf

Description of Change:

Qualification of palladium coated copper (PdCu) bond wire in selected products of the 90K and 120K wafer technology available

in 44L MQFP package at ANAP.

Pre Change:

Gold (Au) bond wire

Post Change:

Palladium coated copper (PdCu) bond wire or Gold (Au) bond wire

Impacts to Data Sheet:

None

Reason for Change:

To improve manufacturability and qualify PdCu bond wire at ANAP assembly site.

Change Implementation Status:

In Progress

Estimated First Ship Date:

August 1, 2015 (date code: 1531)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Markings to Distinguish Revised from Unrevised Devices:

Traceability code

Revision History:

April 07, 2015: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the

applicable products.

Attachment(s): PCN_JAON-180BAP766_Qual_Plan.pdf

PCN_JAON-18OBAP766_Affected_CPN.pdf PCN_JAON-18OBAP766_Affected_CPN.xls

Please contact your local Microchip sales office with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to change your product/process change notification (PCN) profile please log on to our website at http://www.microchip.com/PCN sign into myMICROCHIP to open the myMICROCHIP home page, then select a profile option from the left navigation bar.

To opt out of future offer or information emails (other than product change notification emails), click here to go to microchipDIRECT and login, then click on the "My account" link, click on "Update profile" and un-check the box that states "Future offers or information about Microchip's products or services."







